# Compact 200-265 Vac Hi-PF Boost LED Driver 

ON Semiconductor

| Device | Application | Input Voltage | Output Power | Topology | I/O Isolation |
| :--- | :--- | :---: | :---: | :---: | :--- |
| NCP1075 <br> NCP4328A | LED Driver | $200-265$ Vac | Up to 13 Watts | Boost | Non-isolated |


| Constant Current Output | 30 mA |
| :--- | :--- |
| Nominal Voltage | 393 Vdc |
| Maximum Voltage | 440 Vdc |
| Minimum Voltage | 380 Vdc |


| Typical Power Factor | 0.96 |
| :--- | :--- |
| Typical THDi | $14 \%$ |
| Typical Efficiency | $91.8 \%$ |
| Startup Time | $<20 \mathrm{msec}$ |

## Circuit Description

High voltage LEDs are becoming more popular and are now available from multiple LED manufacturers such as CREE and Philips-Lumileds, see figure 1. These package LEDs may have typical forward voltages ranging from 24 to $>200 \mathrm{~V}$.


Figure 1: Example High Voltage LED Products
The development of these types of LEDs has been driven in part by the desire to improve the power conversion from the AC mains voltage to the LED string voltage as well as simplifying the driver electronics. In fact in some cases they have been promoted as being 'driverless" since a diode bridge and linear regulator can implement a very simple circuit. There are several drawbacks to this approach. As the LEDs are off for a portion of every line cycle when the input voltage is below the LED forward voltage, more LEDs are needed to produce the desired lumen output. In addition, the LED lamp exhibits over $100 \%$ ripple at $100 / 120 \mathrm{~Hz}$. The impact of low frequency ripple on human performance is not a new concern in the lighting world and there is work underway to study this
effect and set acceptable guidelines for the amount of flicker in LED light sources which are more sensitive since there is no optical persistence as is found in filament lamps. Further information can be found at this website: (http://www.Irc.rpi.edu/programs/solidstate/assist/flicker.asp)

If the LED string can be configured such that the forward voltage $V_{F}$ is greater than the peak AC voltage, this opens the door to use a boost topology to drive the LEDs. The output voltage must be higher than the peak of the applied ac input. This implies $265 \mathrm{Vac} \times 2=375 \mathrm{Vdc}$ as the absolute minimum LED voltage suitable for this boost converter application.

A boost converter can provide high power factor and low THD, regulate accurate current regardless of LED forward voltage and line variation, and address the ripple issue eliminating the need to design with higher quantities of LEDs (or LED area) to achieve the desired lumen output. Note that many low power LEDs can also be arranged in long strings to achieve the required high voltage which is particularly attractive to distributed light applications such as linear tube replacements.

As with many high performance LED drivers, the proposed boost converter provides a constant output current compensating for input line voltage range and variation in LED voltage including temperature variation.

Shown below are the design guidelines for this driver:

- Input range: 200-265 V ac
- Output current: 30 mA typical
- Output voltage: 393 Vdc typical
- Efficiency: >88\%
- Power Factor: >0.9
- Open Load Protection
which could introduce unwanted noise in the ac input. These magnetic components should be spaced as far as possible to avoid possible coupling. A magnetically shielded boost inductor like the part shown in the BOM can improve EMI performance.

Q1 modulates the FB control pin of the NCP1075 providing high power factor control. Q1 performs as a voltage follower based on the shape of the rectified ac input pulling the FB pin low at the ac zero crossings and consequently reducing the peak switching current.

Maximum current for the NCP1075 occurs when the FB pin is about 3.2 volts. The resistor divider formed by R4 and R5 sets the voltage at the base of Q1, and the emitter tied to FB pin is one diode drop higher. R4 is selected to provide a balance between low impedance to drive Q1 and minimal dissipation. 540 k meets these criteria by dissipating about 125 mW . Note that two 1206 devices connected in series are required due to voltage and power stress on this resistor. R5 was empirically selected as 5.6 k to optimize THD and PF at nominal 230 Vac input. A 10 nF capacitor provides some noise filtering at this node.

The LED current has been set at 30 mA , so with a typical LED voltage of 393 V , this equates to a nominal output power of 11.7 W .

Selecting the current sense resistor, R7, is as simple as dividing the reference voltage by the output current:

$$
\begin{aligned}
\text { R7 } \quad & =\text { Vref / lout } \\
& =0.0625 / 0.030 \\
& =-2 \Omega
\end{aligned}
$$

A $6.8 \mu \mathrm{~F} 500$ volt output filter capacitor was selected to maintain small component size and good filtering. Derating maximum voltage stress to 440 volts prolongs the useful life of the capacitor. Selecting a capacitor rated $105{ }^{\circ} \mathrm{C}$ with long operating life also enhances reliability.

A resistor divider is used to monitor the output voltage, and in order to minimize dissipation and voltage stress, the upper resistor is realized with two 1206 devices in series. R9 and R9A are selected as $1.74 \mathrm{M} \Omega$ each for a total of $3.48 \mathrm{M} \Omega$. Given the voltage control loop has a reference of 1.250 volts, this means the lower divider resistor, R10, follows the equation:

$$
\begin{aligned}
\mathrm{R} 10 & =(\text { Vref*R9) / (Vout }- \text { Vref }) \\
& =(1.250 * 3.48 \mathrm{M} \Omega) /(440-1.250) \\
& =9.91 \mathrm{k} \Omega, \text { or use } 10 \mathrm{k} \Omega
\end{aligned}
$$

Noise filtering is provided by placing a 10 nF capacitor across R10.

## DN05062/D

A capacitor is required after the input diode bridge, providing low impedance at high frequency for the inductor charging current. Ideally, this capacitor will have minimal change in voltage as the inductor charges minimizing ripple which the EMI filter must attenuate. However, this capacitor must follow the rectified ac mains in order to provide high power factor. At this power level, 100 nF is a good balance between these factors.

The design is complimented with an input filter comprised of two off-the-shelf compact drum inductors, an X capacitor, transient voltage suppressor and a fuse. The Xcapacitor and inductors should provide attenuation without excessive dissipation or reactive current which would degrade power factor. Two 1.5 mH inductors and a 47 nF capacitor were tested and found to meet conducted emission requirements.

A miniature axial fuse keeps the design compact and the 1 amp rating helps in passing input ac line surge current to the MOV transient suppressor without opening.

A complete schematic is shown in Figure 3 and the bill of materials is shown in Figure 8.

A prototype unit was built targeting a small board outline designed to be compatible with popular lamp base enclosures. The narrow portion holding the EMI filter easily fits inside a GU10 bayonet or E27 screw base to utilize all available volume. The wider portion accommodates the high voltage output capacitor and boost inductor.

Figure 2 shows a photo of the PCB which measures 0.95 inches by 1.365 inches ( 24 mm by 35 mm ).


Figure 2: Demonstration Board
Performance is highlighted in Figures 4 and 5 showing current regulation, efficiency, Power Factor, and THD.

Input current harmonic limits for lighting are specified in IEC 61000-3-2 Class C and this design meets the more stringent requirements for applications over 25 W . Typical data is provided in the graph shown in Figure 6.

The conducted EMI profile meets the CISPR22 Class B limits with at least 6 dB margin. The signature is shown in Figure 7.


Figure 3: Schematic


Figure 4: Current Regulation and Efficiency


Figure 5: Power Factor and THD


Figure 6: Class C Harmonics at $230 \mathrm{~V} \mathrm{ac}, 50 \mathrm{~Hz}$


Figure 7: EMI Signature

| DN05062/D |  |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Ref | Qty | Type | Value | Description | $\begin{gathered} \text { Tol } \\ (+l-) \end{gathered}$ | Footprint | Manufacturer | Part Number |
| C1 | 1 | Capacitor | 47nF | 310 Vac Metallized Polyester | 20\% | Box | Vishay | BFC233820473 |
| C2 | 1 | Capacitor | 100nF | 310 Vac Metallized Polyester | 20\% | Box | Vishay | BFC233820104 |
| C3 | 1 | Capacitor | 1uF | 16 V Ceramic X7R | 10\% | $\begin{aligned} & 0603 \\ & \text { SMD } \end{aligned}$ | TDK | C1608X7R1C105K080AC |
| C4 | 1 | Capacitor | 1 nF | 50 V Ceramic NPO | 10\% | $\begin{aligned} & 0603 \\ & \text { SMD } \end{aligned}$ | TDK | C1608C0G1H102K080AA |
| C5 | 1 | Capacitor | 6.8uF | 500 V Electrolytic, 8000Hrs | 10\% | Radial | UCC | EKXJ501ELL6R8MJ20S |
| C6 | 1 | Capacitor | 3.3nF | 50 V Ceramic X7R | 10\% | $\begin{aligned} & 0603 \\ & \text { SMD } \end{aligned}$ | TDK | CGA3E2X7R1H332K080AA |
| C7 | 1 | Capacitor | 33nF | 50V Ceramic X7R | 10\% | $\begin{aligned} & \text { Uivil } \\ & 0603 \\ & \text { SMD } \end{aligned}$ | TDK | C1608X7R1H333K080AA |
| C8 C9 | 2 | Capacitor | 10 nF | 50 V Ceramic X7R | 10\% | $\begin{aligned} & 0603 \\ & \text { SMD } \end{aligned}$ | TDK | C1608X7R1H103K080AA |
| D1 | 1 | Diode | HD06-T | Rectifier bridge, $600 \mathrm{~V}, 0.8 \mathrm{~A}$ | - | SMD | Diodes Inc. | HD06-T |
| D2 | 1 | Diode | MUR160 | $600 \mathrm{~V}, 1 \mathrm{~A}$ | - | SMA | ON Semiconductor | MUR160RLG |
| D3 | 1 | Diode | BAS16 | 100V,200mA | - | SOD-523 | ON Semiconductor | BAS16XV2T1G |
| F1 | 1 | Fuse | 1A | PICO, FAST, 250Vac | - | Axial | Littelfuse | 0263001.WRT1L |
| L1 L2 | 2 | Inductor | 1.5 mH | Drum Inductor, 0.19A | 10\% | Radial | Wurth | 7447462152 |
| L3 | 1 | Inductor | 2.2 mH | Shielded Inductor, 0.32A | 10\% | Radial | Wurth | 7447471222 |
| Q1 | 1 | Transistor | PNP | 65V, 100mA | - | SOT-23 | ON Semiconductor | BC857BLT1G |
| R1 R2 | 2 | Resistor | 6k2 | 1/4W | 5\% | $\begin{aligned} & 1206 \\ & \text { SMD } \\ & \hline \end{aligned}$ | Panasonic | ERJ-8GEYJ622V |
| $\begin{aligned} & \text { R3 } \\ & \text { R3A } \end{aligned}$ | 2 | Resistor | 1 Meg | 1/4W | 5\% | $\begin{aligned} & \text { vivid } \\ & 1206 \\ & \text { SMD } \end{aligned}$ | Panasonic | ERJ-8GEYJ105V |
|  |  |  |  |  |  | $1206$ |  |  |
| R4A | 2 | Resistor | 270k | 1/4W | 1\% | SMD | Panasonic | ERJ-8ENF2703V |
| R5 | 1 | Resistor | 5k6 | 1/10W | 1\% | $\begin{aligned} & 0603 \\ & \text { SMD } \end{aligned}$ | Panasonic | ERJ-3EKF5601V |
| R6 | 1 | Resistor | 1 Meg | 1/10W | 1\% | $\begin{aligned} & 0603 \\ & \text { SMD } \end{aligned}$ | Panasonic | ERJ-3EKF1004V |
|  |  |  |  |  |  | 1206 |  |  |
| R7 | 1 | Resistor | 2 | 1/4W | 1\% | SMD | Vishay | CRCW12062R00FKEA |
| R8 | 1 | Resistor | 22k | 1/10W | 1\% | $\begin{aligned} & 0603 \\ & \text { SMD } \\ & \hline \end{aligned}$ | Panasonic | ERJ-3EKF2202V |
| R9 |  |  |  |  |  | 1206 |  |  |
| R9A | 1 | Resistor | 1.74 Meg | 1/4W | 1\% | SMD | Vishay | CRCW12061M74FKEA |
|  |  |  | 10 k |  |  | $\begin{aligned} & 0603 \\ & \text { SMD } \\ & \hline \end{aligned}$ |  |  |
| RV1 | 1 | M M 隹 | 495V | 275Vac, 11J varistor | 1\% | Disc | Panasonic | V430ZA05P |
|  |  | Controller |  |  |  |  |  |  |
| U1 | 1 | Controiler | NCP1075 | Switcher, 65 kHz | - | SOT-223 | ON Semiconductor | NCP1075STAT3G |
| U2 | 1 | Controller | NCP4328 | Sec Side CV/CC controller | - | TSOP5 | ON Semiconductor | NCP4328ASNT1G |

Figure 8: Bill of Materials
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Design note created by Jim Young, e-mail: james.young@onsemi.com

